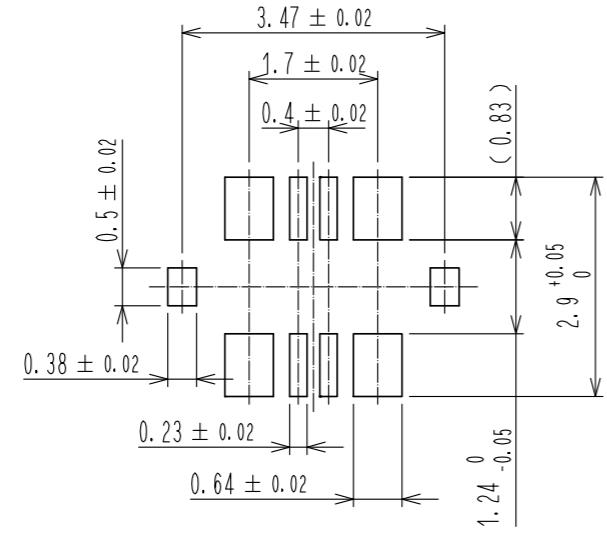
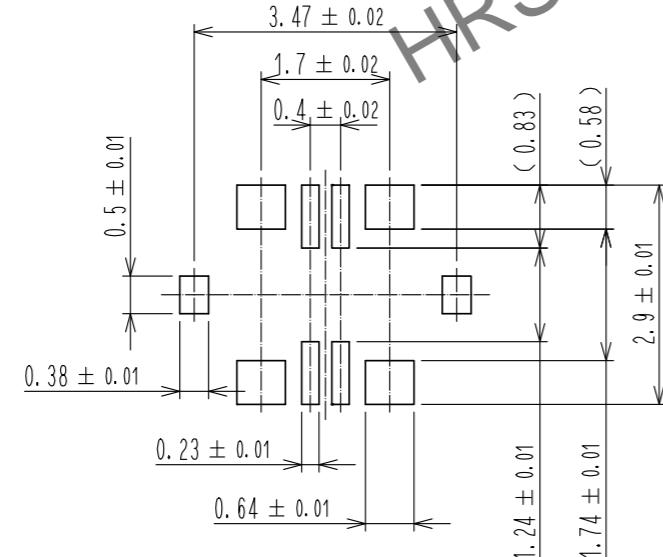


◆ Recommended PCB layout

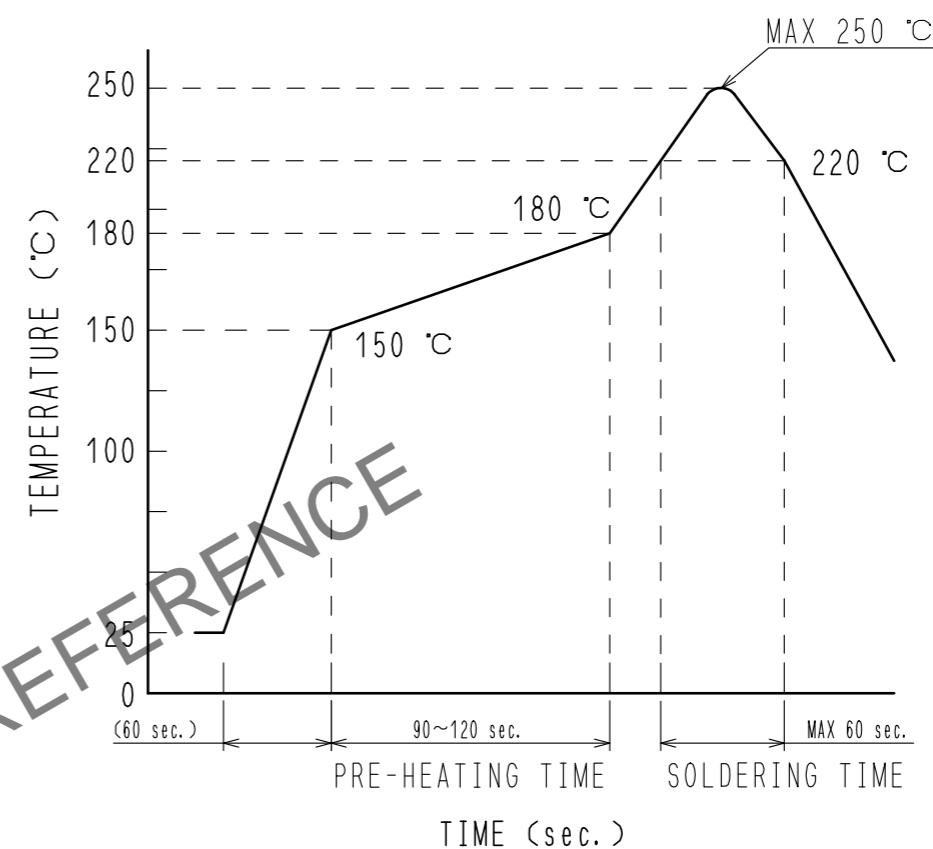


◆ Recommended metal mask dimensions

Metal mask thickness : 100  $\mu\text{m}$



4) Recommended reflow temperature profile using lead-free solder paste.



Reflow method:IR reflow

Number of reflow cycles:2 cycles MAX.

1)Reflow time

Duration above 220°C, 60 sec MAX.  
(Peak temperature:250°C MAX)

2)Pre-heat time

Pre-heat temperature(MIN):150°C  
Pre-heat temperature(MAX):180°C  
Pre-heat time:90-120 sec.

4) The temperatures mentioned above refer to the PCB surface temperature near the connector leads.  
The temperature profiles are based on the above conditions.  
In individual applications the actual temperature may vary,  
depending on solder paste type, volume/thickness and board size/thickness.  
Consult your solder paste and equipment manufacturer for specific recommendations.

5. Please contact us in case you will make different settings from our recommendation.

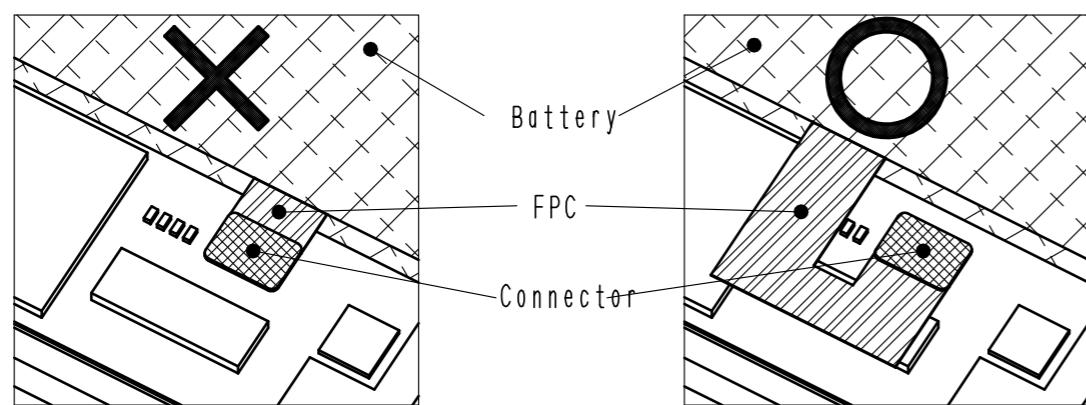


△10. PLEASE REFER TO THE PRODUCT GUIDELINE ETAD-H1018 FOR DETAIL OF CONNECTOR HANDLING.

A How to draw the FPC

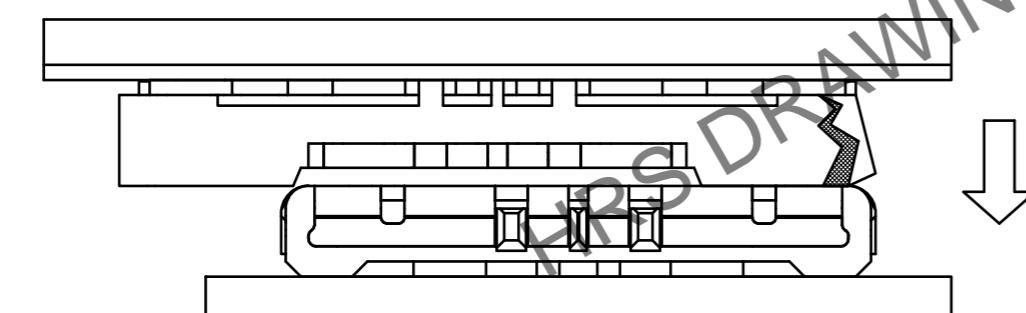
BM25 series connector is intended to carry 10A electrical current for battery application. FPC may have less flexibility than usual, since the copper foil becomes wider and thicker to carry current of 10A.

Please design the FPC to have a flexibility to absorb the displacement\* of the connector caused by fixing PCB and battery.

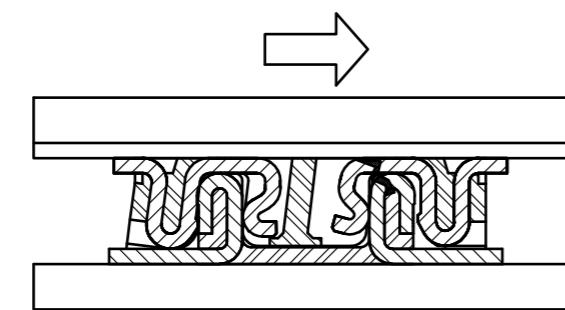


\*Possible problems caused by connector mating in incorrect positioning.  
Mating the connector in incorrect positioning could lose the function of the connector.

① Insulator could be broken.



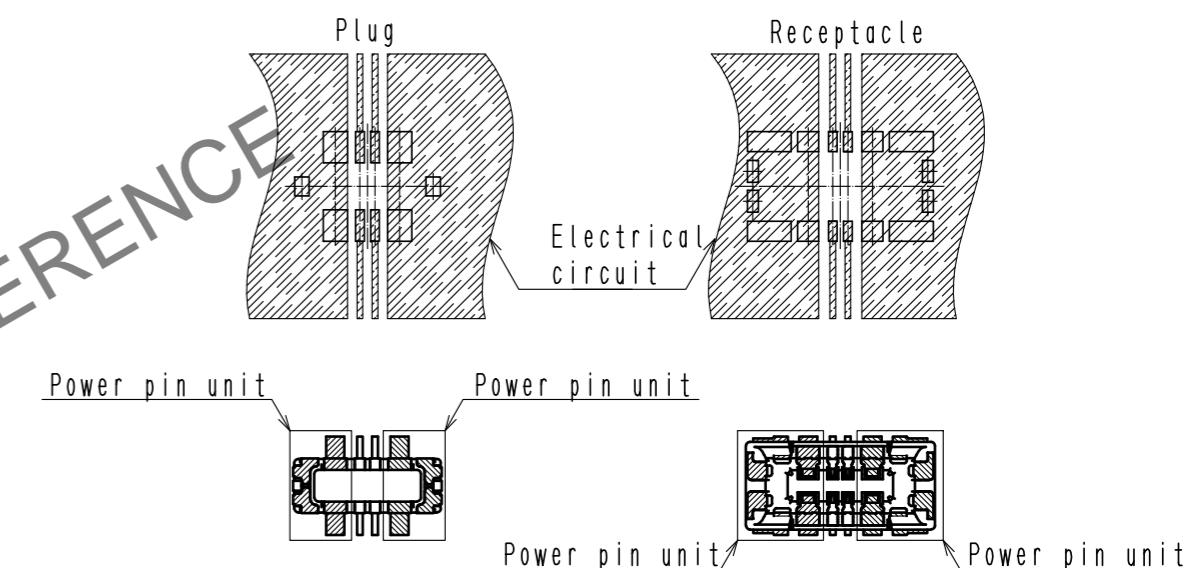
② It could apply excessive mechanical stress to single side of the contact.



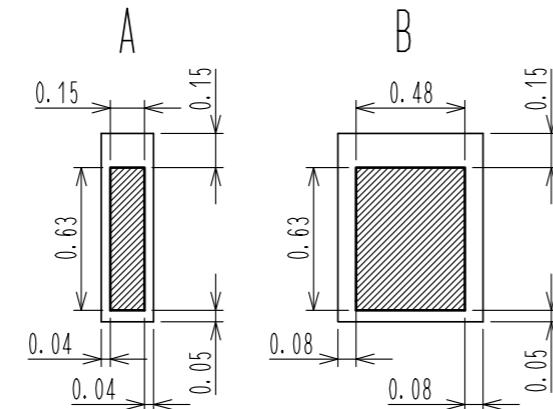
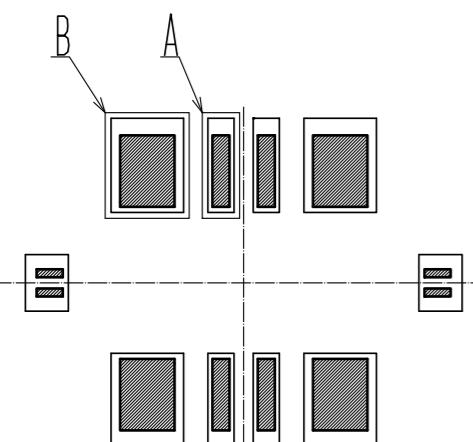
A How to draw the electrical circuit

As shown in the figure below, each power supply unit including the lock metal fitting has to be mounted on the same PCB circuit.

◆ Recommended electrical circuit layout



## A THE POSITION BETWEEN THE CONNECTOR AND PAD



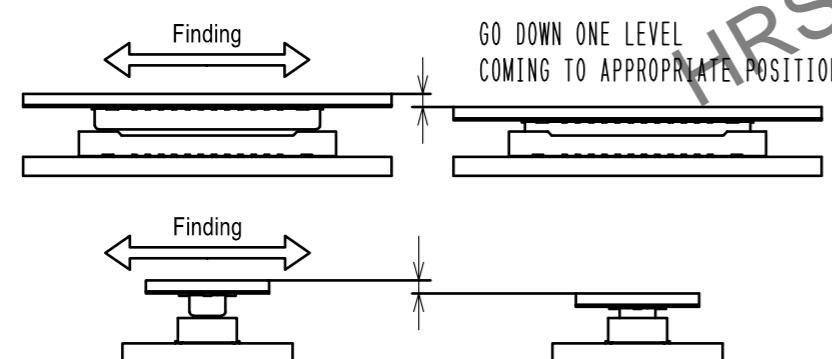
■ Connector lead on PAD layout  
□ PAD layout

## C MATING METHOD

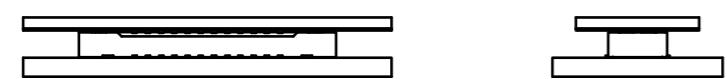
PLEASE MATE THE CONNECTOR BY HAND.

### MATING PROCEDURE

(1) FIND THE ALIGNMENT AREA TO THE CONNECTOR IN THE APPROPRIATE MATING POSITION.  
THIS CONNECTOR HAS AN ALIGNMENT CHAMBER(GUIDANCE RIBS) ON RECEPTACLE SIDE AND R<sup>1</sup> ON PLUG SIDE.  
SO THAT THE CONNECTOR WILL BE SELF-ALIGNED.  
WHEN THE CONNECTOR COMES TO THE APPROPRIATE POSITION, THE CONNECTOR GOES INTO THE ALIGNED POSITION.  
WHEN ALIGNED, IT CAN BE FELT BY HAND.



(2) WHEN GUIDING, THE CONNECTORS ARE ALIGNED PARALLEL TO EACH OTHER, WITH LONGITUDINAL AND LATERAL MOVEMENTS RESTRICTED. MATE THEM PROPERLY BY APPLYING FORCE IN THIS CONDITION.

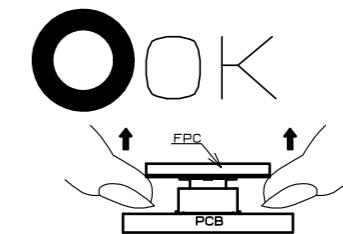
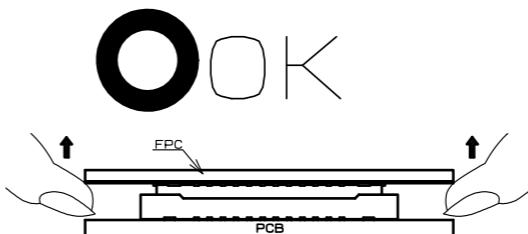


(3) MAKE SURE THE CONNECTORS ARE MATED CORRECTLY. IF ONE SIDE IS FLOATING OR THE CONNECTORS ARE MATED IN ONE DIRECTION, UN-MATE THEM ONCE, AND THEN MATE THEM AGAIN, FOLLOWING THE PROCEDURES ABOVE FROM THE BEGINNING.

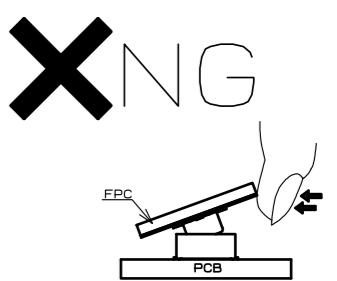
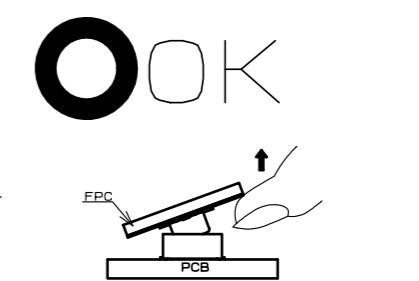
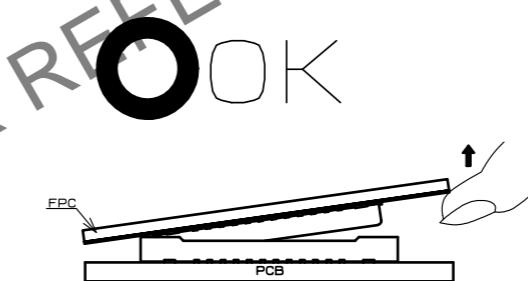
## A UN-MATING METHOD

PLEASE UN-MATE THE CONNECTOR BY HAND

(1) UN-MATE THE CONNECTORS PARALLEL TO EACH OTHER. HOWEVER, IF THE CONNECTORS HAVE HIGH PIN COUNTS OR THINNER FPC AND STIFFENER, IT BECOMES MORE DIFFICULT TO DO SO.



(2) IF THE CONNECTOR CANNOT BE UN-MATED PARALLEL IT CAN BE REMOVED DIAGONALLY FROM THE PITCH DIRECTION.  
BE CAREFUL TO DO SO SINCE THIS ACTION APPLIES STRESS ON THE CONTACT.



(3) IF THE FPC IS NOT RIGID, THE CONNECTOR CAN BE BROKEN. PLEASE CHECK THE ACTION OF THE FPC TO BE USED REPEATEDLY AT THE TIME OF TRIAL PRODUCTION. BE CAREFUL TO UN-MATE THEM FROM THE PITCH DIRECTION.  
PULLING IT FROM THE CORNER CAN ALSO RISK TO PUTTING STRESS ON CONTACTS.

